Docket No. 33417/US

Declaration For Patent Application

	English L	anguage Declaration	
As a below named in	ventor, I hereby declar	e that:	
My residence, post o	ffice address and citize	enship are as stated below next to m	y name,
first and joint invento		entor (if only one name is listed belo isted below) of the subject matter w ntitled	-
CEILING PANELING	SYSTEM		
the specification of w	hich		
(check one)			
☐ is attached hereto	D .		
☑ was filed on 29 J	July 2003	as United States Application No	or PCT International
Application Numb	oer		
and was amende	d on		
		(if applicable)	
<u> </u>		derstand the contents of the above in the above in the content referred to above.	identified specification,
•	•	United States Patent and Trademarkity as defined in Title 37, Code of	
Section 365(b) of an any PCT International listed below and have	y foreign application(s al application which des e also identified below or PCT International a	der Title 35, United States Code, s) for patent or inventor's certificate signated at least one country other to by checking the box, any foreign a oplication having a filing date before	e, or Section 365(a) of han the United States, pplication for patent or
Prior Foreign Applica	tion(s)		Priority Not Claimed
02078119.1	Europe	30 July 2002	
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	П

(Number)

(Day/Month/Year Filed)

(Country)

I hereby claim the benefit under application(s) listed below:	35 U.S.C. Section 119(e) of any United States provisional
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
Section 365(c) of any PCT Internations insofar as the subject matter of ear United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to make the section 112 of the section 112.	ional application designating ich of the claims of this application in the manner parties the duty to disclose to the lie to be material to patental be between the filing date of	any United States application(s), or the United States, listed below and, plication is not disclosed in the prior provided by the first paragraph of 35 United States Patent and Trademark ability as defined in Title 37, CFR the prior application and the national
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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